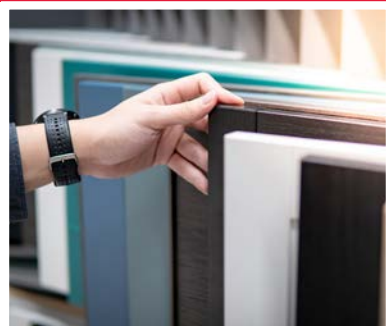




Jowat-Toptherm®

237.50



Unfilled edgebanding adhesive based on PO

High heat resistance

“Zero bondline”

Outstanding bonding strength

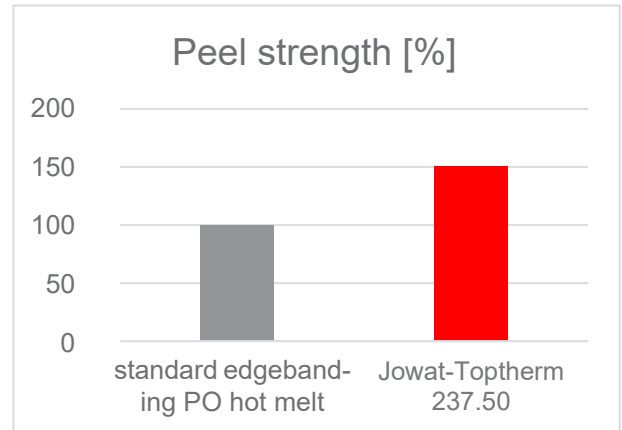
Optimised stringing

Improved yield

Jowat-Toptherm® 237.50 is an unfilled edgebanding adhesive based on polyolefin (PO), which impresses due to high heat resistance, outstanding bond strengths, a wide range of adhesion and a superior appearance of the adhesive joint. This hot melt adhesive provides a good alternative to PUR adhesives for processors when a wide range of adhesion and a “zero bondline” are required. In many cases, investments into new machinery are not necessary.

In addition, **Jowat-Toptherm® 237.50** is in conformity with REACH and, compared to reactive adhesives that are subject to hazard labelling requirements, facilitates highest protection of employees and the environment.

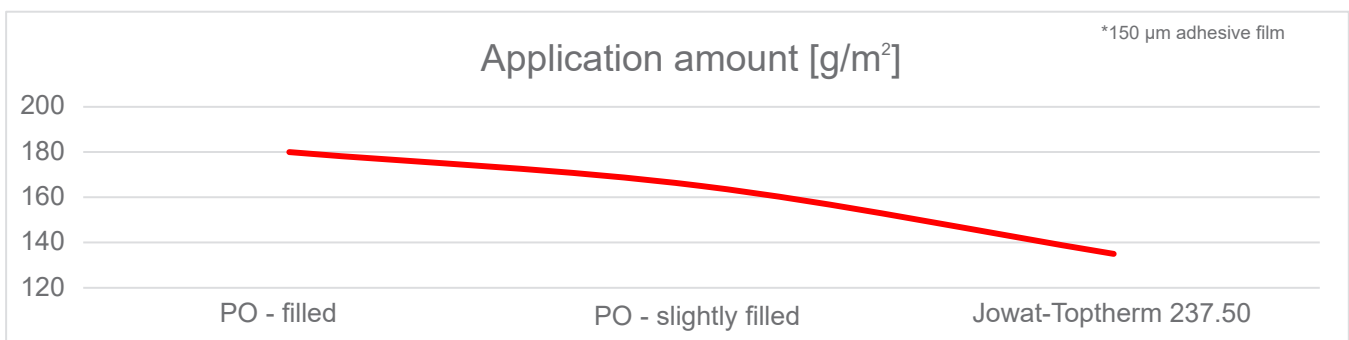
Jowat-Toptherm® 237.50 does not contain any filling agents. This makes it possible to manufacture virtually invisible, colourless adhesive joints, especially on dark decors and high-gloss furniture fronts, with an outstanding yield.



Jowat-Toptherm® 237.50

For automatic edgebanders. Wide range of applications, e.g. for edgebands made of PVC, ABS, PP, resinated paper or veneer.

Polymer base		PO
Processing temperature	[°C]	190 - 210
Density	[g/cm ³]	approx. 0.9
Viscosity at 200 °C	[mPas]	approx. 110,000
Softening range	[°C]	approx. 125 (Kofler bench)
Appearance		colourless



The information given in this leaflet is based on test results from our laboratories as well as on experience gained in the field, and does in no way constitute any guarantee of properties. Due to the wide range of different applications, substrates, and processing methods beyond our control, no liability may be derived from these indications nor from the information provided by our free technical advisory service. Before processing, please request the corresponding data sheet and observe the information in it! Customer trials under everyday conditions, testing for suitability at normal processing conditions, and appropriate fit-for-purpose testing are absolutely necessary. For the specifications as well as further information, please refer to the latest technical data sheets.